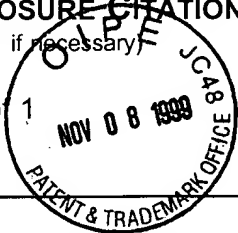


FORM HDP-1449 (Based on Form PTO-1449)  <b>PATENT AND TRADEMARK OFFICE</b> <b>INFORMATION DISCLOSURE CITATION</b> (Use several sheets if necessary)  Sheet 1 of 1	ATTORNEY DOCKET NO.  9319S-000062	SERIAL NO.  09/068,270
	APPLICANT  Kenji UCHIYAMA	
	FILING DATE  May 4, 1998	GROUP  2822



U.S. PATENT DOCUMENTS						
Ref. Desig.	Examiner's Initials	Document Number	Date	Name	Class/ Subclass	(If appropriate) Filing Date
1.	JMM	4,604,644	08/1986	Beckham et al		
2.	I	5,187,123	02/1993	Yoshida et al		
3.	I	5,232,962	08/1993	Dershem et al		

FOREIGN PATENT DOCUMENTS							
Ref. Desig.	Examiner's Initials	Document Number	Date	Country	Class/ Subclass	Translation	
						Yes	No
1.	JMM	0 265 077	1988	European Patent Office			
2.	I	0 517 071 A1	1992	European Patent Office			

OTHER DOCUMENTS (including Author, Title, Date, Pertinent Pages, etc.)		
Ref. Desig.	Examiner's Initials	
1.	JMM	Gilleo, K., "Direct Chip Interconnect Using Polymer Bonding", IEEE Transactions on Components, Hybrids and Manufacturing Technology, Vol 13, No. 1, 1 March 1990, pps 229-234.
2.	I	Jin, Sungho et al, "Anisotropically Conductive Polymer Films with a Uniform Dispersion of Particles", IEEE Transactions on Components, Hybrids and Manufacturing Technology, Vol. 16, No. 8, 1 December 1993, pps 972-977.

Examiner:	Date Considered:
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